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Vishay Semiconductors

High Speed Infrared Emitting Diodes, 890 nm, **Surface Emitter Technology**





DESCRIPTION

As part of the SurfLight™ portfolio, the VSMY2890 series are infrared, 890 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- · Automotive sensors
- Photointerrupters
- Emitter source for proximity sensors
- IR illumination

FEATURES

 Package type: surface-mount · Package form: GW, RGW

• Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.8

AEC-Q101 qualified

• Peak wavelength: $\lambda_p = 890 \text{ nm}$

• Angle of half intensity: $\varphi = \pm 10^{\circ}$

• Suitable for high pulse current operation

· Terminal configurations: gullwing or reverse gullwing

 Package matches with detector VEMD2500X01 series

Floor life: 4 weeks, MSL 2a, according to J-STD-020

· Material categorization: for definitions of compliance please see www.vishav.com/doc?99912







FREE **GREEN**

PRODUCT SUMMARY				
COMPONENT	I_e (mW/sr) at I_F = 100 mA	φ (°)	$\lambda_{\mathbf{P}}$ (nm)	t _r (ns)
VSMY2890RGX01	135	± 10	890	15
VSMY2890GX01	135	± 10	890	15

Note

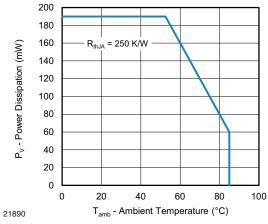
· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY2890RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMY2890GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

· MOQ: minimum order quantity



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward current		I _F	100	mA
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	Α
Power dissipation		P _V	190	mW
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	According to Fig. 9, J-STD-020	T _{sd}	260	°C
Thermal resistance junction-to-ambient	JESD51	R _{thJA}	250	K/W





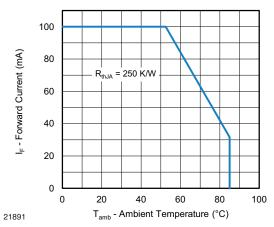


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}	-	1.7	1.9	V
Forward voltage	$I_F = 1 \text{ A}, t_p = 100 \ \mu\text{s}$	V _F	-	2.8	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-2.0	-	mV/K
Reverse current		I _R	Not designed for reverse operation µA		μΑ	
Junction capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0 \text{ mW/cm}^2$	CJ	-	60	-	pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	50	135	175	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l _e	-	1000	-	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фe	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	TKφ _e	-	-0.12	-	%/K
Angle of half intensity		φ	-	± 10	-	0
Peak wavelength	I _F = 100 mA	λ_{p}	870	890	910	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	35	-	nm
Temperature coefficient of λ _p	I _F = 100 mA	TKλ _p	-	0.3	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	15	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	15	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

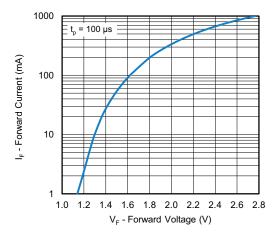


Fig. 3 - Forward Current vs. Forward Voltage

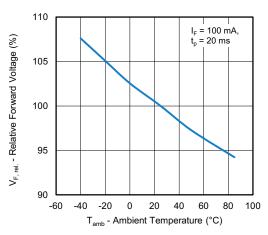


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

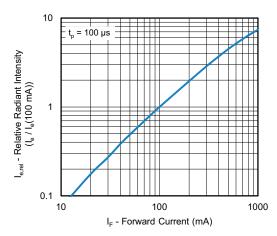


Fig. 5 - Relative Radiant Intensity vs. Forward Current

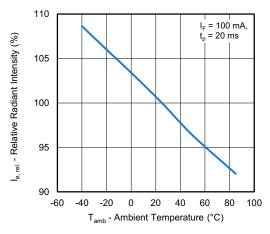


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

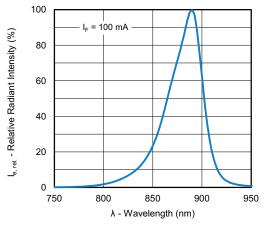


Fig. 7 - Relative Radiant Intensity vs. Wavelength

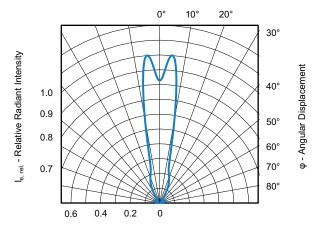


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

VSMY2890RGX01, VSMY2890GX01

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SOLDER PROFILE

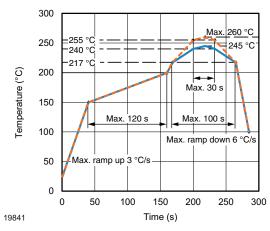


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

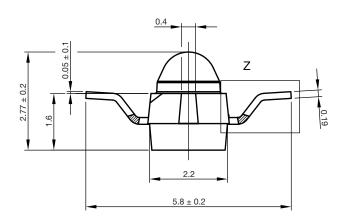
Conditions: T_{amb} < 30 °C, RH < 60 %

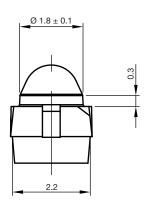
Moisture sensitivity level 2a, according to J-STD-020.

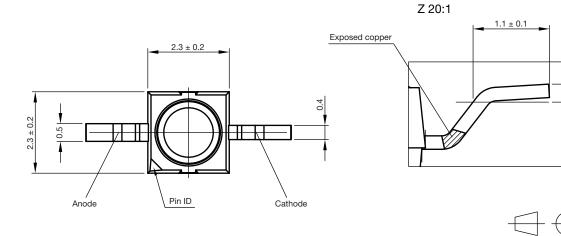
DRYING

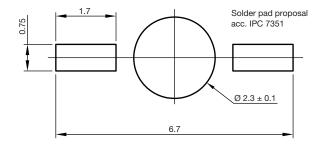
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

PACKAGE DIMENSIONS in millimeters: VSMY2890RGX01







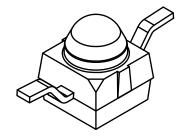


according to DIN specifications

technical drawings

0.254

Not indicated tolerances ± 0.1

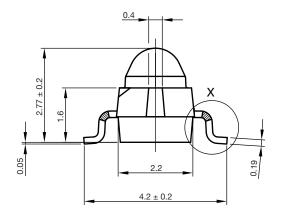


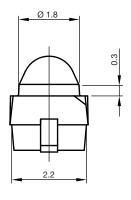
Drawing-No.: 6.544-5391.03-4

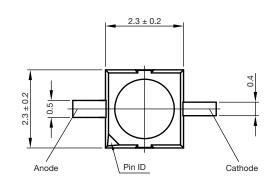
Issue: 1; 18.03.10

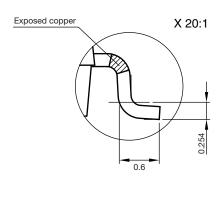
22100

PACKAGE DIMENSIONS in millimeters: VSMY2890GX01

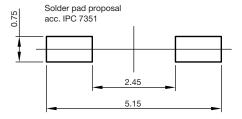




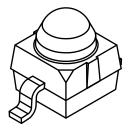








Not indicated tolerances ± 0.1



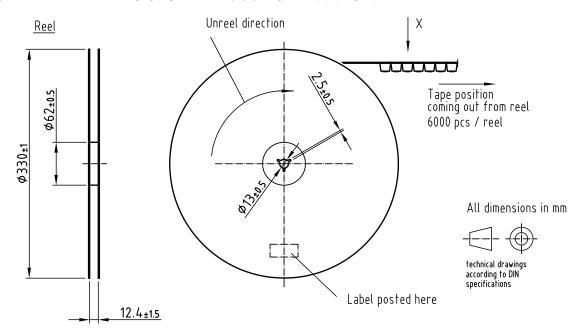
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Issue: 1; 18.03.10

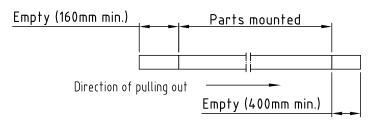
22099



TAPING AND REEL DIMENSIONS in millimeters: VSMY2890RGX01

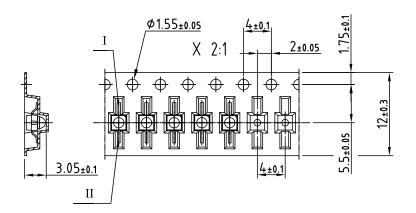


Leader and trailer tape:



Terminal position in tape

Device	Lead I	Lead II
VEMT 2000	Collector Emitte	
VEMT 2500	Collector	Emiliei.
VEMD 2000		
VEMD 2500		
VSMB 2000	Cathode	Anode
VSMG 2000	Carriode	Alloue
VSMF 2890 RG		
VSMB 294008 RG		
VSMY 2xxx		
	Anode	Cathode
VSMF 288011 RG		

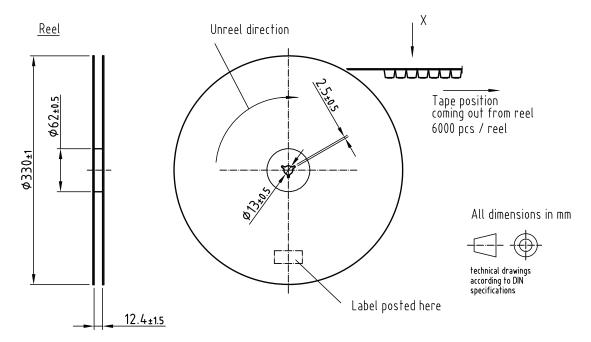


Drawing refers to following types: Reel dimensions and tape see table

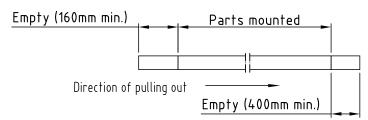
Drawing-No.: 9.800-5100.01-4 Issue: preliminary, 11.07.19



TAPING AND REEL DIMENSIONS in millimeters: VSMY2890GX01

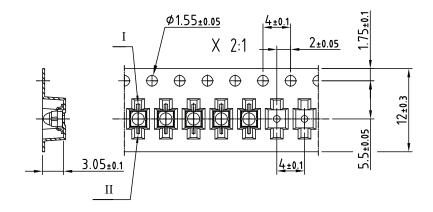


Leader and trailer tape:



Terminal position in tape

Device	Lead I	Lead II	
VSMB 2020			
VSMG 2020			
VEMD 2020	Cathode	Anode	
VEMD 2520	Carnoue		
VSMF 2890 G			
VSMB 294008 G			
VEMT 2020	C . II	F=:44	
VEMT 2520	Collector	Emitter	
VSMY 2xxx			
	Anode	Cathode	
VSMF 288011 G			



Drawing refers to following types: see table

Drawing-No.: 9.800-5091.01-4 Reel dimensions and tape Issue: preliminary, 11.07.19



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